CLAIMS

We claim:

1 1. A method of forming a security enclosure, comprising:

providing an electronic assembly;

enclosing the assembly in a tamper respondent wrap,

such that the wrap forms fold lines at a first and second

5 end of the assembly;

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placing the enclosed assembly in a fixture, wherein the fixture comprises a base upon which the assembly rests, a first stationary arm mounted on the base holding the fold lines at the first end of the assembly, a second arm slidably mounted on the base, and a traversing mechanism to bias the second arm toward the fold lines at the second end of the assembly; and

heating the enclosed assembly.

- 2. The method of claim 1, further comprising heating the enclosed assembly at a temperature of approximately 60 °C.
- 3. The method of claim 1, further comprising heating the
- enclosed assembly at a temperature of approximately 40-90
- °C.

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- 1 4. The method of claim 1, further comprising heating the
- enclosed assembly for approximately 1 hour.
- 5. The method of claim 1, wherein the fixture comprises a
- 2 clamping device.
- 1 6. The method of claim 1, wherein the tamper respondent wrap
- 2 comprises a flexible material having tamper respondent
- 3 detection devices.
 - 7. The method of claim 1, wherein the tamper respondent wrap comprises:
 - at least one pierce and laser respondent layer;
 - a delamination respondent layer; and
 - an adhesive between the pierce and laser respondent layer and the delamination respondent layer.
- 1 8. The method of claim 7, wherein the pierce and laser
- 2 respondent layer and the delamination respondent layer
- 3 comprise a plurality of ink lines on at least one side of
- 4 the pierce and laser respondent layer and the delamination
- 5 respondent layer.

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1	9.	The	method	of	claim	1,	wherein	the	electronic	assembly

comprises a cryptographic processor.

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1	10.	The	method	οĒ	claim	9,	wherein	the	cryptographic

processor comprises a printed circuit board, having mounted

thereon:

an encryption module to carry secured sensitive

information;

a memory to store a key necessary to access the information;

an erase circuit to erase the information in the encryption module in the event the tamper respondent wrap is breached; and

an enclosure monitor to activate the erase circuit in the event a breach is detected.

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1	11.	A	method	of	producing	a	tamper	respondent	enclosure,
2	comp	ori	sing:						

enclosing a cryptographic processor in a tamper respondent sheet, wherein an adhesive material secures the enclosure;

holding the enclosed cryptographic processor such that the adhesive material remains intact; and

applying heat to the enclosed cryptographic processor to strengthen the adhesive material.

- 12. The method of claim 11, further including holding the enclosed cryptographic processor in a clamping device.
- 13. The method of claim 11, further including applying heat at a temperature of approximately 60 °C.
- 1 14. The method of claim 11, further including applying heat
- 2 at a temperature of approximately 50-70 °C.

- 15. A method of forming a security enclosure, comprising: 1
- providing a circuit card; 2
- enclosing the card in a tamper respondent cloth, 3
- wherein an adhesive secures fold lines of the cloth;
- holding the fold lines of the cloth to maintain 5
- adhesive contact; and 6
- 7 heating the enclosed card.
- 16. The method of claim 15, further comprising holding the 1 cloth in a clamping device to maintain the adhesive contact.
 - 17. The method of claim 16, wherein the clamping device comprises:
 - a base upon which a security enclosure rests;
 - a first stationary arm mounted on the base, which holds a first end of the security enclosure;
- a second arm slidably mounted on the base; and 6
- a traversing mechanism to bias the second arm toward a 7
- 8 second end of the security enclosure.

- 1 18. The method of claim 15, further comprising heating the
- enclosed card at approximately 60 °C for approximately 1
- 3 hour.
- 1 19. The method of claim 15, further comprising curing the
- 2 adhesive.
- 1 20. The method of claim 15, wherein the circuit card
- 2 comprises a cryptographic processor.

- 21. A method of assembling a security enclosure comprising:

 providing a fixture;

 providing an enclosure having a cloth member thereon;

 placing the enclosure in the fixture;

 heating the enclosure; and
- 1 22. The method of claim 21, wherein the fixture comprises a clamping device.

removing the enclosure from the fixture.

- 23. The method of claim 22, wherein the clamping device comprises:
 - a base upon which a security enclosure rests;
- a first stationary arm mounted on the base, which holds a first end of the security enclosure;
 - a second arm slidably mounted on the base; and
- a traversing mechanism to bias the second arm toward a second end of the security enclosure.
- 1 24. The method of claim 21, wherein the enclosure comprises
- a circuit assembly having a tamper respondent cloth wrapped
- 3 therearound.

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- 1 25. The method of claim 21, wherein heating comprises
- 2 exposing the enclosure to a temperature of approximately 50-
- 3 70 °C for about 1 hour.

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1	26. An apparatus for securing a security enclosure,
2	comprising;
3	a base upon which a security enclosure rests;
4	a first stationary arm mounted on the base, which holds
5	a first end of the security enclosure;
6	a second arm slidably mounted on the base; and
7	a traversing mechanism to bias the second arm toward a

second end of the security enclosure.